Ceramic properties



2000

EAAC

250

Alumina (MAC-A940W)

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Description

Alumina ceramic of **94% Al₂O₃** content. Its excellent combination of mechanical, thermal, electrical and chemical properties are well suited to applications across industry.

Prime features

- Dense, non porous and vacuum tight.
- High mechanical strength and hardness.
- Low thermal expansion.
- High volume resistivity.
- · Resists abrasion and chemical attack.
- Consistent dielectric constant.
- Readily accepts moly-manganese metallizing for high temperature brazing of assemblies.

Typical applications

- Pressure sensors for fluid flow measurement.
- Wear and barrier coatings for sputtering targets.
- Electron tube components.
- · Laser components.

Specifications

• Quality Assurance to ISO 9002.

MAC production capabilities

- Isostatic and dry pressing, green machining.
- CNC grinding and lapping to very tight tolerances.
- Metallising of components.
- · High temperature brazing of assemblies.
- Prototype, batch and volume production.

Physical properties*

| Color | White |
|--------------------------------------|------------------|
| Bulk density (fired), Mg/m³ [lb/in³] | 3.67 [0.132] |
| Porosity (apparent), % | 0 (fully dense) |
| Rockwell hardness (R45N) | 78 |
| Compressive strength, MPa [lb/in²] | >2070 [>300,000] |
| Flexural strength, MPa [lb/in²] | 345 [50,000] |

Thermal conductivity, W/m.K [BTU/ft.hr.ºF] @RT 20.5 [11.9]

| Thermal | expansion | coefficient, | 10 ⁻⁶ /C | [10 ⁻⁶ /°F] |
|---------|-----------|--------------|---------------------|------------------------|
| | | | | |

| Maximum no-load temperature, C [°F] | 1600 [2910] |
|-------------------------------------|-------------|
| 800-1000C [1470-1830°F] | 9.1 [5.1] |
| 600-800C [1110-1470°F] | 8.6 [4.8] |
| 400-600C [750-1110°F] | 8.0 [4.4] |
| 200-400C [390-750°F] | 7.5 [4.2] |
| 25-200C [77-390°F] | 6.3 [3.5] |

Dielectric strength, dc kV/mm [V/mil] @RT 25.6 [650]

| | | 250 | 3000 | 500C |
|---------------------------------------|-----------|---------|---------|---------|
| Dielectric constant, K ^I , | @ 10MHz | 9.07 | 9.53 | 9.91 |
| | @ 1000MHz | 9.04 | _ | _ |
| | @ 8500MHz | 8.98 | 9.26 | 9.40 |
| Dissipation factor, tan $\delta,$ | @ 10MHz | 0.00026 | 0.00028 | 0.00341 |
| | @ 1000MHz | 0.00062 | _ | _ |
| | @ 8500MHz | 0.00078 | 0.00155 | 0.00155 |
| Loss factor, K^{l} .tan δ , | @ 10MHz | 0.00236 | 0.00267 | 0.03369 |
| | @ 1000MHz | 0.00560 | _ | _ |
| | @ 8500MHz | 0.00700 | 0.01165 | 0.01457 |

Volume resistivity, ohm.cm

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|-------------------------|-----------------|----------------------|
| | @ 25C [77°F] | > 1014 |
| | @ 300C [570°F] | 2.0x10 ¹² |
| | @ 600C [1110°F] | 4.6x10 ⁸ |
| | @ 900C [1650°F] | 3.5×10^6 |
| Te value, C [°F] | | >950 [>1740] |

